



MURA105T3, MURA110T3

Preferred Devices

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.66 Volts Max @ 1.0 A, $T_J = 150^\circ\text{C}$)

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3)
Machine Model > 400 V (Class C)
- Marking: U4A, U4B

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R	50	
		100	
Average Rectified Forward Current	$I_{F(AV)}$		A
@ $T_L = 155^\circ\text{C}$		1.0	
@ $T_L = 135^\circ\text{C}$		2.0	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I_{FSM}	50	A
Operating Junction Temperature Range	T_J	- 65 to +175	$^\circ\text{C}$

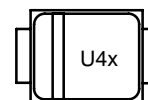
Surface Mount Ultrafast Power Rectifiers

**ULTRAFAST RECTIFIERS
1 AMPERE
50-100 VOLTS**



SMA
CASE 403D
PLASTIC

**MARKING
DIAGRAM**



x = A (105T3)
B (110T3)

ORDERING INFORMATION

Device	Package	Shipping
MURA105T3	SMA	5000/Tape & Reel
MURA110T3	SMA	5000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Lead (Note 1)	Ψ_{sJL}	24	$^{\circ}C/W$
Thermal Resistance, Junction to Ambient (Note 1)	$R_{\theta JA}$	216	

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 3) ($i_F = 1.0\text{ A}$, $T_J = 25^{\circ}C$) ($i_F = 1.0\text{ A}$, $T_J = 150^{\circ}C$)	V_F	0.875 0.66	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 150^{\circ}C$)	i_R	2.0 50	μA
Maximum Reverse Recovery Time ($i_F = 1.0\text{ A}$, $di/dt = 50\text{ A}/\mu s$)	t_{rr}	30	ns

1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.
2. In compliance with JEDEC 51, these values (historically represented by $R_{\theta JL}$) are now referenced as Ψ_{sJL} .
3. Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

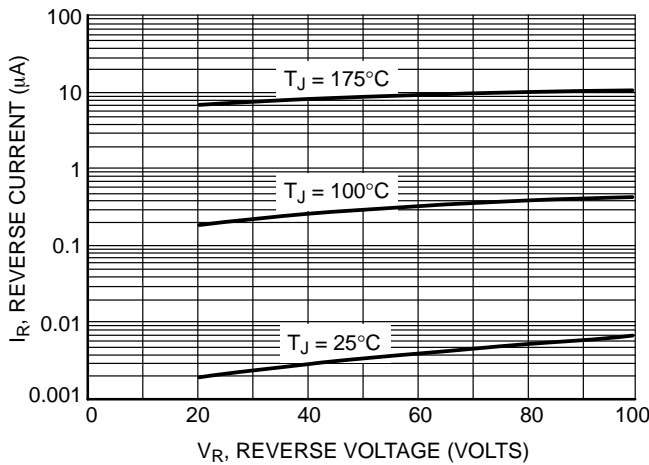


Figure 1. Typical Reverse Current

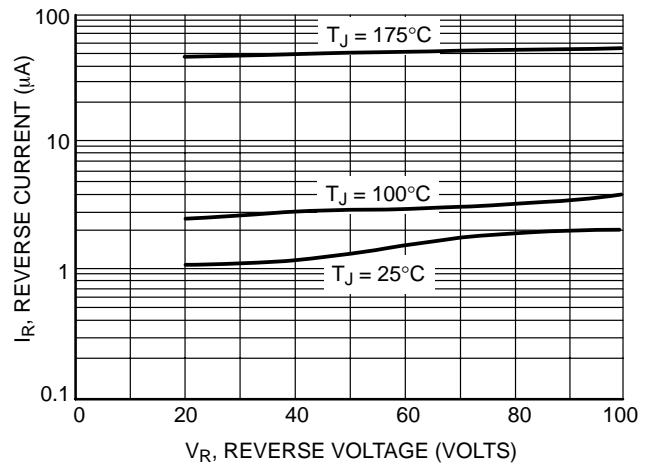


Figure 2. Maximum Reverse Current

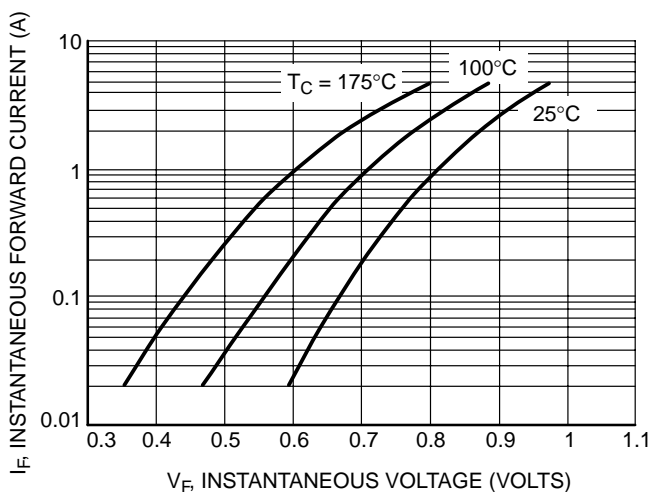


Figure 3. Typical Forward Voltage

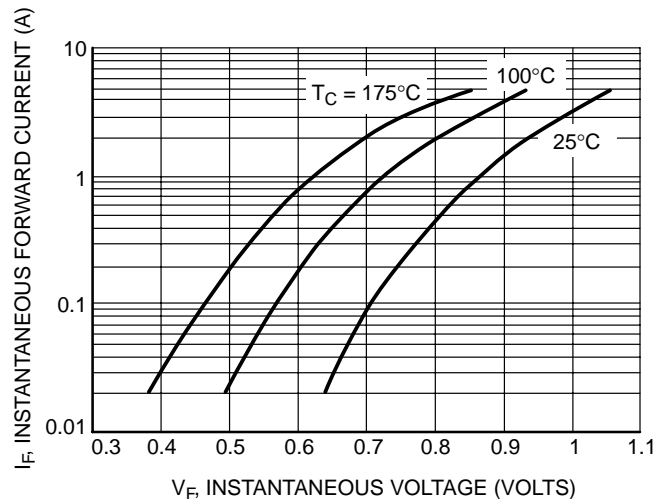


Figure 4. Maximum Forward Voltage